# **YIDONG REN**

+1-517-219-6227 | renyidon@msu.edu | https://ydren001.github.io/

428 S. Shaw Lane, East Lansing, MI - 48824, USA

#### RESEARCH INTERESTS

- Internet of Things: Satellite IoT in rural areas [MobiCom'24 C1]. Cross-soil agricultural IoT [MobiCom'24 C2].
- Low-power Wireless Communication/Networking: Physical layer encoder decoder design [MobiSys'24, MobiCom'24 C6, MobiHoc'23, ICLR'23 ML4IoT]. Batteryless communication [INFOCOM'23].
- Mobile Computing: Wearable system [SenSys'24]. Channel adapted Wi-Fi [TMC'22].

#### **EDUCATION**

Michigan State University

East Lansing, USA

Ph.D. Candidate, Department of Computer Science and Engineering

2021 - Present

Advisor: Zhichao Cao

University of Electronic Science and Technology of China

Chengdu, China

B.E., Electronic and Information Engineering

2017 - 2021

## **CONFERENCE PUBLICATIONS**

 $^{*}$  denotes equal contribution,  $\_$  are students I mentor

First-author papers:

**MobiCom 2024 [C1]** SateRIoT: High-performance Ground-Space Networking for Rural IoT.

Yidong Ren, Amalinda Gamage, Li Liu, Mo Li, Shigang Chen, Younsuk Dong, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiCom 2024 [C2] Demeter: Reliable Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

Yidong Ren, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao

Liu, Tianxing Li, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiSys 2024 [C3] ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT.

Yidong Ren\* (co-primary author), Chenning Li\*, Shuai Tong, Shakhrul Iman Siam, Mi Zhang,

Jiliang Wang, Yunhao Liu, Zhichao Cao.

The 22nd ACM International Conference on Mobile Systems, Applications, and Services

Acceptance ratio: 16.35%

**INFOCOM 2023 [C4]** Prism: High-throughput LoRa Backscatter with Non-linear Chirps.

**Yidong Ren**, Puyu Cai, Jinyan Jiang, Jialuo Du, Zhichao Cao.

IEEE Conference on Computer Communications, 2023

Acceptance ratio: 19.21%

ICNP 2022 [C5] Is Lorawan Really Wide? Fine-grained LoRa Link-level Measurement in An Urban Environ-

ment

Yidong Ren\* (co-primary author), Li Liu\*, Chenning Li\*, Zhichao Cao and Shigang Chen.

The 30th IEEE International Conference on Network Protocols.

Acceptance ratio: 21.43%

Other papers:

MobiCom 2024 [C6] LoRaTrimmer: Optimal Energy Condensation with Chirp Trimming for LoRa Weak Signal

Decoding.

Jialuo Du, Yunhao Liu, Yidong Ren, Li Liu, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

SenSys 2024 [C7] PiezoBud: A Piezo-Aided Secure Earbud with Practical Speaker Authentication.

Gen Li\*, Huaili Zeng\*, Hanqing Guo, **Yidong Ren**, Aiden Dixon, Zhichao Cao and Tianxing Li.

The 22nd ACM Conference on Embedded Networked Sensor Systems.

Acceptance ratio: 18.53%

MobiHoc 2023 [C8] SRLoRa: Neural-enhanced LoRa Weak Signal Decoding with Multi-gateway Super Resolu-

tion.

Jialuo Du, Yidong Ren, Zhuizhu, Chenning Li, Zhichao Cao, Qiang Ma, Yunhao Liu.

The 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for

Mobile Networks and Mobile Computing

Acceptance ratio: 22.06%

## **JOURNAL PUBLICATIONS**

TMC [J1] Morph: ChirpTransformer-based Encoder-decoder Co-design for Reliable LoRa Communication.

Yidong Ren, Maolin Gan, Mi Zhang, Shigang Chen, Zhichao Cao.

Under review of IEEE Transactions on Mobile Computing

TMC [J2] NELoRa++: Towards General Neural-enhanced LoRa Demodulation.

Maolin Gan\*, Khang Nguyen\*, Jialuo Du, Yidong Ren, Huacheng Zeng, Mi Zhang, Shigang Chen,

Zhichao Cao.

Under review of IEEE Transactions on Mobile Computing

TMC [J3] Channel Adapted Antenna Augmentation for Improved Wi-Fi Throughput.

Yanbo Zhang, Weiping Sun, Yidong Ren, Sung-ju Lee, Mo Li.

IEEE Transactions on Mobile Computing, 2022.

#### BENCKMARK

ICLR ML4IoT NELoRa-Bench: A Benchmark for Neural-enhanced LoRa Demodulation.

Jialuo Du, Yidong Ren, Mi Zhang, Yunhao Liu and Zhichao Cao.

International Conference on Learning Representations Workshop on Machine Learning for IoT,

2023. Oral

# **DEMO**

MobiCom 2024 Demeter-Demo: Demonstrating Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

**Yidong Ren**, Yawen Wang, Younsuk Dong, Shigang Chen, Mi Zhang, Jiliang Tang, Zhichao Cao. The 30th Annual International Conference On Mobile Computing And Networking (**Demo**)

#### INTERNSHIP EXPERIENCE

Qualcomm, WLAN System Team. Santa Clara, CA, USA

06/2024 - 09/2024

Research on DNN-assisted Wi-Fi CSI localization and Deep reinforcement learning for Wi-Fi roaming.

Nanyang Technological University, WADNS Group, Singapore

07/2019 - 10/2019

Channel adaptive Wi-Fi intelligent antenna selection system. Advisor: Mo Li

# TEACHING EXPERIENCE

# Michigan State University, Department of Computer Science and Engineering

Teaching Assistant

• CSE 220 — Programming in C

Spring 2022, Spring 2023, Spring 2024

CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2022

Guest Lecturer

CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2023

#### **ACADEMIC SERVICE**

# Programm Committee of

•	USENIX Security Artifact Evaluation	2025
•	ACM MobiCom Artifact Evaluation	2024

• ACM MobiCont Attract Evaluation 2024

ACM MobiSys Artifact Evaluation
ACM SenSys Artifact Evaluation

• IEEE International Conference on Parallel and Distributed Systems (ICPADS) 2024

# Invited Journal Reviewer of

IEEE/ACM Transactions on Networking	2023-2024
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• IEEE Transactions on Mobile Computing 2024

• ACM Transactions on Sensor Network 2022-2024

#### Conference Reviewer of

IEEE International Symposium on Dynamic Spectrum Access Networks (DySpan)
2022-2023

• EAI MobiQuitous 2022

MENTORSHIP			
Puyu Cai	02/2022-12/2022		
Now: Master student at Computer Science Department, New York University			
Khang Nguyen, Nam Nguyen	03/2023 - Present		
Now: Honor College, Michigan State University			
Honor and Awards			
Dissertation Completion Fellowship, Graduate School at Michigan State University	2025		
Distinguished Artifact Reviewer, ACM MobiCom	2024		
Student Travel Grant, ACM MobiCom	2024		
Student Travel Grant, ACM MobiSys	2024		
Student Travel Grant, ACM MobiHoc	2023		
Student Travel Grant, IEEE ICNP	2022		
GRANTS EXPERIENCE			
I assisted in the preparation of proposals for the following research grants:			
<b>NSF:</b> LoRa Enabled Space-air-ground Integrated Networks for Next-Generation Agricultural IoT. Award number 2338976.			
<b>NSF:</b> Towards High-Performing LoRa with Embedded Intelligence on the Edge. Award number 2312674.			
TALKS			
ACM MobiSys 2024, Tokyo, Japan	06/2024		
Conference Presentation			
"ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT"			

06/2024

05/2023

Tsinghua University, Beijing, China

"Reliable Cross-soil LPWAN for agricultural  $\mbox{IoT}^{\prime\prime}$ 

"Prism: High-throughput LoRa Backscatter with Non-linear Chirps"

IEEE INFOCOM 2023, New York City, USA

Invited Talk

Conference Presentation